

SPECIFICATION FOR LCD Module

Customer P/N:

Santek P/N: ST0280A3W-RSLW-F

DOC. Revision: RS02

Customer Approval:

	SIGNATURE	DATE
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1. GENERAL SPECIFICATION

1.1. Description

The ST0280A3W-RSLW-F is a color active matrix Thin Film Transistor (TFT) Liquid Crystal Display (LCD) that uses amorphous silicon(a-Si) TFT as a switching device. This model is composed of a single 2.8 inches transmissive type main TFT-LCD panel. The resolution of the panel is 240 x 320 pixels and can display up to 262K color.

1.2. Feature

-TM type for main TFT-LCD panel

- -Structure COG+FPC+BL
- -Full, Normal (Still), Partial, Sleep, Standby mode are available

1.3. Application

-Display terminals for cellular phone or equivalent.

1.4. General Specification

No.	Item	Specification	Unit	Remark
1	LCD Size	2.8	inch	-
2	Panel Type	a-Si TFT active matrix	-	-
3	Resolution	240 x (RGB) x 320	pixel	-
4	Display Mode	Normally white, Transmissive	-	-
5	Display Number of Colors	262K	-	-
6	Viewing Direction	6 o'clock(Gray Scale)	-	Note
7	Contrast Ratio	500(TYP)	-	-
8	Luminance	210(TYP)	cd/m ²	-
9	Module Size	50.00(W) x 69.20(L) x 2.40(T)	mm	Note
10	Active Area	43.20(W) x 57.60(L)	mm	Note
11	Pixel Pitch	0.180(W) x 0.180(L)	mm	-
12	Weight	-	g	-
13	Driver IC	ST7789V	-	-
14	Light Source	4 LEDs White	-	-
15	Interface	CPU 8/16bit	-	-
16	Operating Temperature	-20~70	°C	-
17	Storage Temperature	-30~80	°C	-

Note: Please refer to the mechanical drawing.



File No. 2017110201

2. BLOCK DIAGRAM





File No. 2017110201

3. MECHANICAL DRAWING



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4. INTERFACE ASSIGNMENT

PIN NO.	SYMBOL	FUNCTION DESCRIPTIONS
1	GND	Ground.
2	/CS	A chip selection signal. When CS is low,the chip can be accessed.
3	RS	Display data/command selection pin in MCU interface. RS='1': display data or parameter. RS='0': command data.
4	/WR	Serves as a write signal and writes data at the rising edge.
5	/RD	Serves as a read signal and read data at the rising edge.
6~13	DB10-DB17	Data bus.
14~23	DB0-DB9	Data bus.
24	/RESET	Reset pin.
25	IMO	MCU parallel interface type selection. IM3='1' and IM0='0': i80-system 16-bit interface. DB[17:10], DB[8:1] is used;
26	IM3	IM3='1' and IM0='1': i80-system 8-bit interface. DB[17:10] is used;
27	GND	Ground.
28	NC	No connection
29	NC	No connection
30	NC	No connection
31	NC	No connection
32	GND	Ground.
33	VCC	Power supply to the analog circuit.
34	IOVCC	Power supply to the interface pins
35	LED-K1	Power supply for backlight (cathode).
36	LED-K2	Power supply for backlight (cathode).
37	LED-K3	Power supply for backlight (cathode).
38	LED-K4	Power supply for backlight (cathode).
39	LED-A	Power supply for backlight (anode).
	NO. 1 2 3 4 5 6~13 14~23 24 25 26 27 28 29 30 31 32 33 34 35 36 37 38	NO. SYMBOL 1 GND 2 /CS 3 RS 3 RS 4 /WR 5 /RD 6~13 DB10-DB17 14~23 DB0-DB9 24 /RESET 25 IMO 26 IM3 27 GND 28 NC 29 NC 30 NC 31 NC 32 GND 33 VCC 34 IOVCC 35 LED-K1 36 LED-K3 38 LED-K4



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5. ELECTRICAL SPECIFICATION 5.1. APPLICATION CIRCUIT





5.2. ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL CONDITION		STAN			
	STWDUL	CONDITION	MIN	TYP	MAX	
Power Supply for Analog	VCC	Ta=25 ⁰C	-0.3	-	4.6	V
Power Supply for Digital IO	IOVCC	Ta=25 ⁰C	-0.3	-	4.6	V

Note: Permanent damage to the device may occur if maximum values are exceeded or reverse voltage is applied.

5.3. TYPICAL OPERATION CONDITION

5.3.1. DC Characteristics

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ITEM	SYMBOL			STANDARD VALUE			
	STWDUL		MIN	ТҮР	MAX	Т	
Power Supply for Analog	VCC	Ta=25 oC	2.4	2.8	3.3	V	
Power Supply for Digital IO	IOVCC	Ta=25 °C	1.65	1.8	3.3	V	
Input Signal "H" Level	VIH		0.7×IOVCC	-	IOVCC	V	
Input Signal "L" Level	VIL	T	-0.3	-	0.3×IOVCC	V	
Output Signal "H" Level	V _{OH}	I _{0н} =-0.1mA	0.8×IOVCC	-	-	V	
Output Signal "L" Level	Vol	I _{OL} =0.1mA	-	-	0.2×IOVCC	V	
Frame Frequency	f _{FRAME}	-	60	70	85	Hz	

Note: To prevent IC latch up or DC operation in LCD panel, the power on/off sequence should follow the driver IC specification.





5.3.2. Current Consumption

ltem	Symbol	Val	ues	Unit	Remark
	Symbol	Min.	Max.	Unit	
Normal(Still) Mode	I _{CC1}	-	10	mA	Note1
Sleep Mode	I _{CC2}	-	100	uA	Note2

Note1: Test Condition

IOVCC=VCC=2.8V;

Display Pattern: All Pixel Black

Frame Rate=77Hz at Line Inversion

Operating Temperature: $25^{\circ}C$

Max. current check pattern:



Note2: In the standby mode, all the internal display operations are suspended including the internal R-C oscillator.



5.4. BACKLIGHT SPECIFICATION

5.4.1. BACKLIGHT CIRCUIT



5.4.2. ELECTRICAL CHARACTERISTICS

(T=25℃)

PARAMETER	SYMBOL	CONDITION	STAN	DARD	VALUE	UNIT
FARAMETER	STNIDOL	CONDITION	MIN	ТҮР	MAX	UNIT
FORWARD VOLTAGE (Single Chip)	VF	IF=15mA	2.9	3.2	3.5	V

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5.5. INTERFACE TIMING CHARACTERISTICS



Figure 1 Parallel Interface Timing Characteristics (8080-Series MCU Interface)

Signal	Symbol	Parameter	Min	Мах	Unit	Description
	D/CX T _{AST} Address setup time		0		ns	
DICA	T _{AHT}	Address hold time (Write/Read)	10		ns	-
	T_{CHW}	Chip select "H" pulse width	0		ns	
	T _{cs}	Chip select setup time (Write)	15		ns	
CSX	T _{RCS}	Chip select setup time (Read ID)	45		ns	
037		Chip select setup time (Read FM)	355		ns	-
	T _{CSF}	Chip select wait time (Write/Read)	10		ns	
	T _{CSH}	Chip select hold time	10		ns	
	Twc	Write cycle	66		ns	
WRX	Twrh	Control pulse "H" duration	15		ns	
	T _{WRL}	Control pulse "L" duration	15		ns	
	T _{RC}	Read cycle (ID)	160		ns	
RDX (ID)	T _{RDH}	Control pulse "H" duration (ID)	90		ns	When read ID data
	T _{RDL}	Control pulse "L" duration (ID)	45		ns	
RDX	T _{RCFM}	Read cycle (FM)	450		ns	When read from
(FM)	T _{RDHFM}	Control pulse "H" duration (FM)	90		ns	frame memory
(1-141)	T _{RDLFM}	Control pulse "L" duration (FM)	355		ns	name memory
D[17:0]	T _{DST}	Data setup time	10		ns	For CL=30pF

VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta= -30 to 70 \mathcal{C}



5.6. RESET TIMING CHARACTERISTICS



Figure 2 RESET TIMING

VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 ~ 70 °C

Related Pins	Symbol	Parameter	MIN	МАХ	Unit
	TRW	Reset pulse duration	10	-	us
RESX	TRT	Reset cancel	-	5 (Note 1, 5)	ms
	IKI	Reset cancer		120 (Note 1, 6, 7)	ms

Notes:

1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.

2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action		
Shorter than 5us	Reset Rejected		
Longer than 9us	Reset		
Between 5us and 9us	Reset starts		

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.



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105°C VCC 10VCC 10V/

6. OPTICAL CHARACTERISTICS

				(T _a =+25°	C,VCC=IO	VCC=+2.8	V,I _{BL} =801	mA)
ltem		Symbol	Conditio n	Values			Unit	Dements
				Min.	Тур.	Max.	Unit	Remark
Viewing Angle Range	Left	θ∟	CR≧10	-	45	-	degre e	Note 1,2
	Right	θ _R		-	45	-		
	Тор	Φτ		-	50	-		
	Bottom	Φ _B		-	20	-		
Response Time		T _{on} +T _{off}	Normal θ=Φ=0°	-	16	-	ms	Note 2,3
Contrast Ratio		CR	Normal θ=Φ=0°	-	500	-	-	Note 2,4
Luminance		L	Normal θ=Φ=0°	190	210		cd/m ²	Note 2,5
Color Chromaticity (CIE1931)	White	Wx	Normal θ=Φ=0°	0.2460	0.2960	0.3460	-	Note 2,6
		Wy		0.2663	0.3163	0.3663		
	Red	R _x		0.5797	0.6297	0.6797		
		Ry		0.3016	0.3516	0.4216		
	Green	Gx		0.2939	0.3439	0.4039		
		Gy		0.5523	0.6023	0.6523		
	Blue	B _x		0.0947	0.1447	0.1947		
		By		0.0241	0.0741	0.1241		
Color Gamut		NTSC	CIE1931	-	55.3	-	%	-
Luminance Uniformity		UL	Normal $\theta = \Phi = 0^{\circ}$	75	80	-	%	Note 2,7

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Note 2: Definition of optical measurement system

The optical characteristics should be measured in a dark room with ambient temperature Ta=+25 $^{\circ}$ C. The optical properties are measured at the center point of the LCD screen after 5 minutes operation. (Equipment: Photo detector TOPCON BM-5AS Field of view: 1°/Height: 500mm.)



Note 3: Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{on}) is the time between photo detector output intensity changed from 90% to 10%, and fall time (T_{off}) is the time between photo detector output intensity changed from 10% to 90%.



Fig. 4 Definition of response time



Note 4: Definition of contrast ratio

Contrast ratio (CR) = $\frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$

Note 5: Definition of luminance

Measured at the center area of the panel when LCD panel is driven at "white" state.

Note 6: Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD when panel is driven at "White", "Red", "Green" and "Blue" state respectively.

Note 7: Definition of luminance uniformity

To test for uniformity, the tested area is divided into 3 rows and 3 columns. The measurement spot is placed at the center of each circle as below.



Fig. 5 Definition of luminance uniformity

 L_{min} : The measured minimum luminance of all measurement position.

 L_{max} : The measured maximum luminance of all measurement position.



7. RELIABILITY TESTS

ITEM	CONDITION	CRITERION			
Operating Temperature Test	High Temperature: +70 ℃±3℃, 72 hrs	No defects in display and			
	Low Temperature: -20 ℃±3℃, 72 hrs	operational functions			
Storage Temperature Test	High Temperature: +80 ℃±3℃, 120 hrs	No defects in display and			
	Low Temperature: -30 ℃±3℃, 120 hrs	operational functions			
Humidity Endurance Test	60 ℃±3℃, 90%±3%RH, 72 hrs	No defects in display and operational functions			
	-30 °C (30mins)~	No defects in display and			
Thermal Shock Test	+80 °C (30mins) 10 cycles	operational functions			
	Operating Time: thirty minutes				
Vibration Resistance Test	exposure for each direction (X,Y,Z)	No defects in display and			
	Sweep Frequency:10~55Hz (1 min)	operational functions			
	Amplitude: 1.5mm				
Mechanical Shock	100G 6ms,±X, ±Y, ±Z 3 times for each				
	direction	operational functions			
Electro Static Discharge	± 2KV, Human Body Mode, 100pF/1500Ω	No defects in display and operational functions			

NOTE:

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1) The samples must be free from defect before test, must be restored at room condition at least for 2 hours after reliability test before any inspection.

2) Before test the function of TP, the sample must be placed in room temperature for 24hrs after RA test.



8. PRECAUTIONS

8.1. HANDLING

8.1.1. Polarizer Cleaning, Petroleum ether (or N-hexane) is recommended for cleaning the front/rear polarizers and reflectors, acetone, toluene and ethanol are not allowed to avoid damaging the surface.

8.1.2. Body grounding, must wear Anti-ESD wrist strap while pick up LCDs.

8.1.3. FPC Soldering, less than 300 ℃/3S, solder must be grounding on grounding bench.

8.1.4. If use electric Screwdriver to do assembly, screwdriver must be grounding.

8.2. STORAGE

- 8.2.1. Keep in a sealed polyethylene bag.
- 8.2.2. Keep in a dark place.

8.2.3. Keep in temperature between $0\,^\circ\!\mathrm{C}\,$ and $35\,^\circ\!\mathrm{C}.$

NOT allowed at 70°C for more than 160 Hours, or at -20°C for more than 48 Hrs.

8.3. SAFETY

If liquid crystal leak out of a damaged glass cell, DO NOT put it in your mouth or touch eyes, if the liquid crystal touch your skin or clothes, please wash it off immediately using soap and water.

9. LIMITED WARRANTY

Unless otherwise agreed between San Technology and customer, San Technology will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with San Technology LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defectsover specs must be returned to San Technology within 30 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of San technology limited to repair and/or replacement on the terms set forth above. San Technology shall not be responsible for any subsequent or consequential events.

9.1. RETURNING LCM UNDER WARRANTY – TERMS AND CONDITIONS

9.1.1. No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.

Circuit modified in any way, including addition of components.

9.1.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB's eyelet, conductors and terminals.